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(12) United States Design Patent

Fojtik

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(54) **APPARATUS FOR SENSING TEMPERATURES WITHIN HOLLOW ORGANS**

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(**) Term: **14 Years**
(21) Appl. No.: **29/361,655**
(22) Filed: **May 13, 2010**
(51) **LOC (10) Cl.** **24-02**
(52) **U.S. Cl.**
USPC **D24/133**
(58) **Field of Classification Search**
USPC D24/133, 140, 143, 147; 600/108, 114, 600/153, 549; 606/41; D7/300.2
See application file for complete search history.

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Primary Examiner — Bridget L Eland
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(57) **CLAIM**

The ornamental design for an apparatus for sensing temperatures within hollow organs, as shown and described.

DESCRIPTION

FIG. **1** is an enlarged frontal perspective view of a first embodiment of an apparatus for sensing temperatures within hollow organs showing my new design;

FIG. **2** is a first side view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **3** is an enlarged second side view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **4** is an enlarged top view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **5** is an enlarged bottom view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **6** is an enlarged front view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **7** is an enlarged rear view of the first embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **1**;

FIG. **8** is an enlarged frontal perspective view of a second embodiment of an apparatus for sensing temperatures within hollow organs according to my new design;

FIG. **9** is a first side view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**;

FIG. **10** is an enlarged second side view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**;

FIG. **11** is an enlarged top view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**;

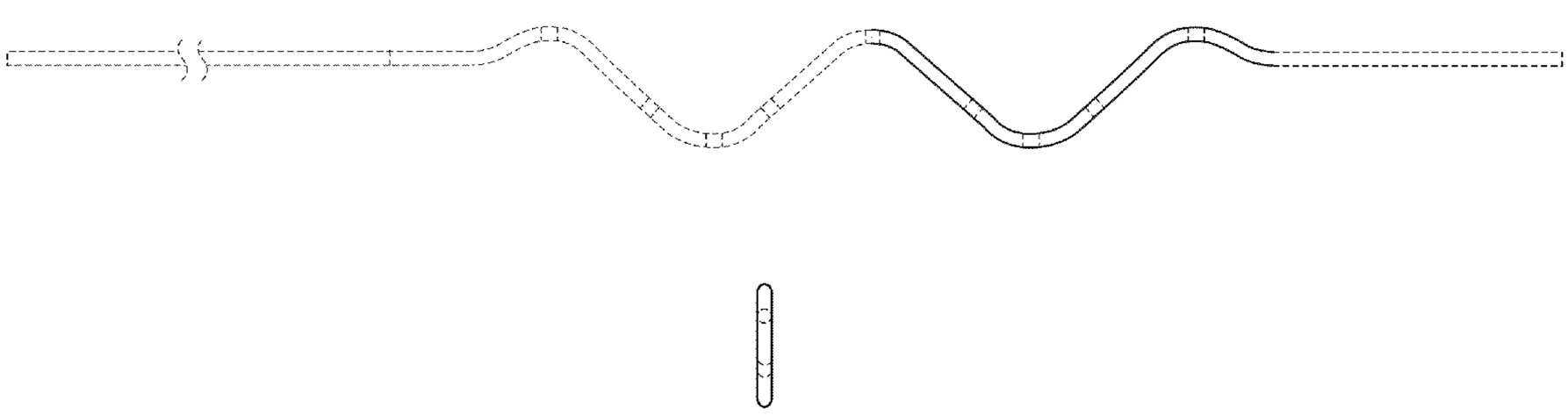
FIG. **12** is an enlarged bottom view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**;

FIG. **13** is an enlarged front view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**; and,

FIG. **14** is an enlarged rear view of the second embodiment of the apparatus for sensing temperatures within hollow organs shown in FIG. **8**.

Broken lines showing a remainder of the apparatus are directed to environment, and are for illustrative purposes only; the broken lines form no part of the claimed design.

1 Claim, 4 Drawing Sheets



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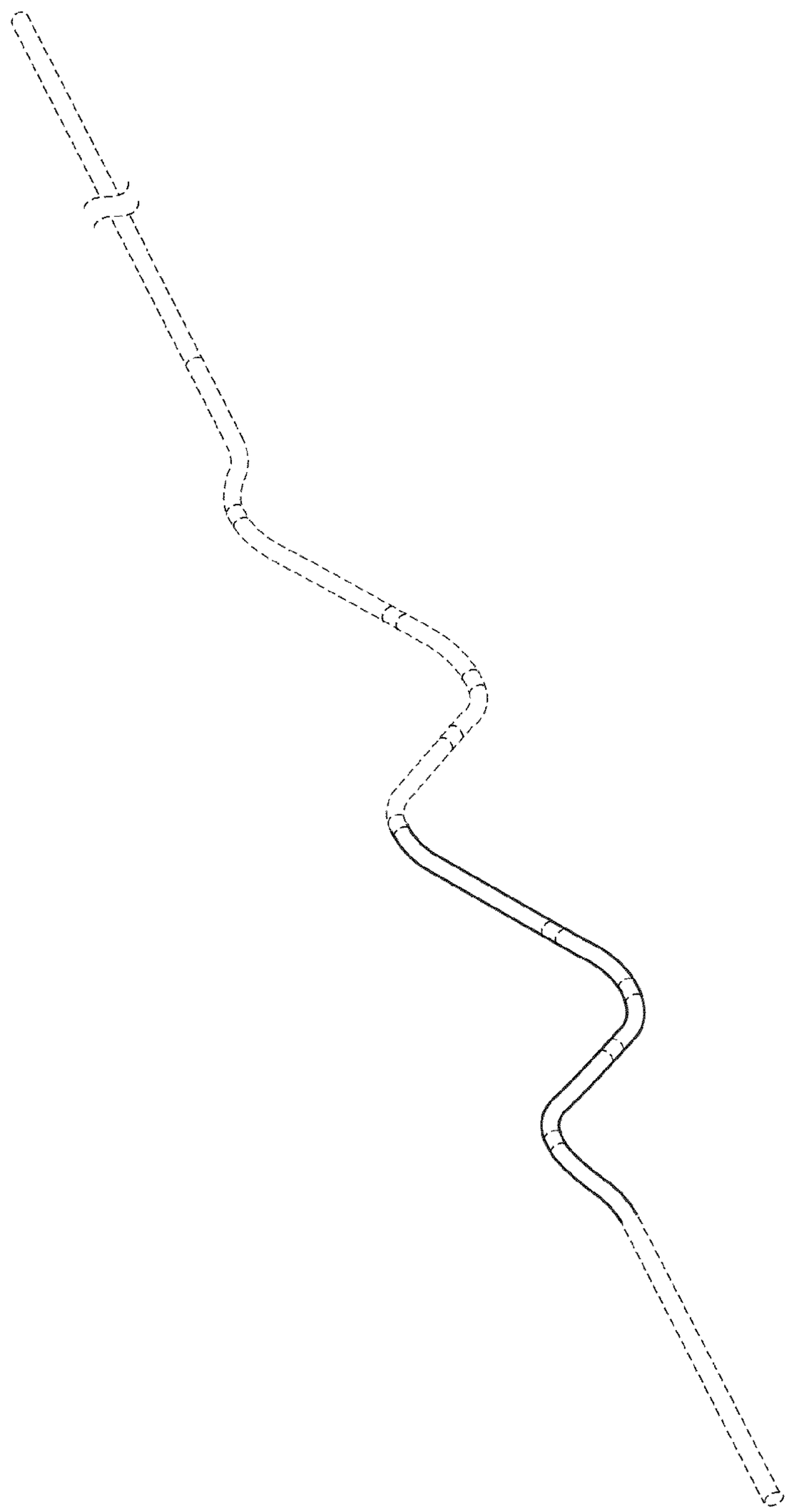

FIG. 1

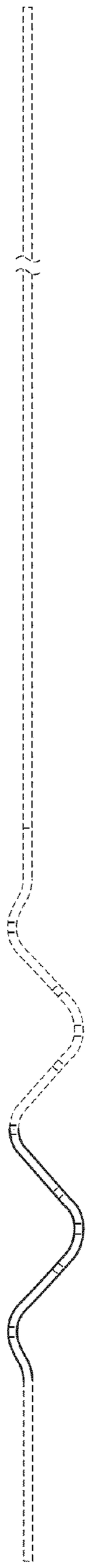

FIG. 2

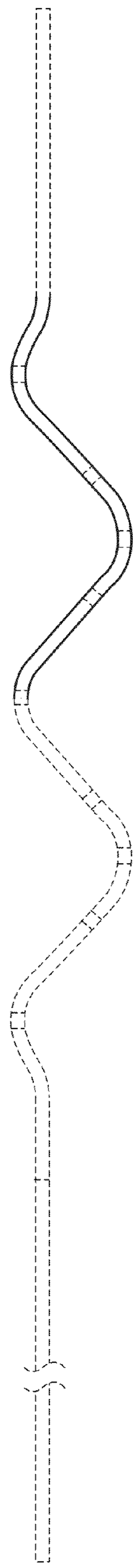

FIG. 3

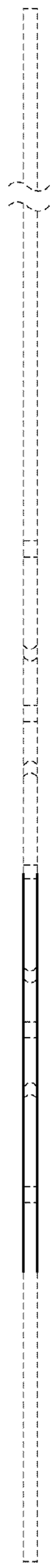

FIG. 4

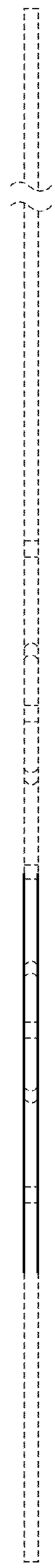

FIG. 5

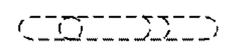

FIG. 7

FIG. 6

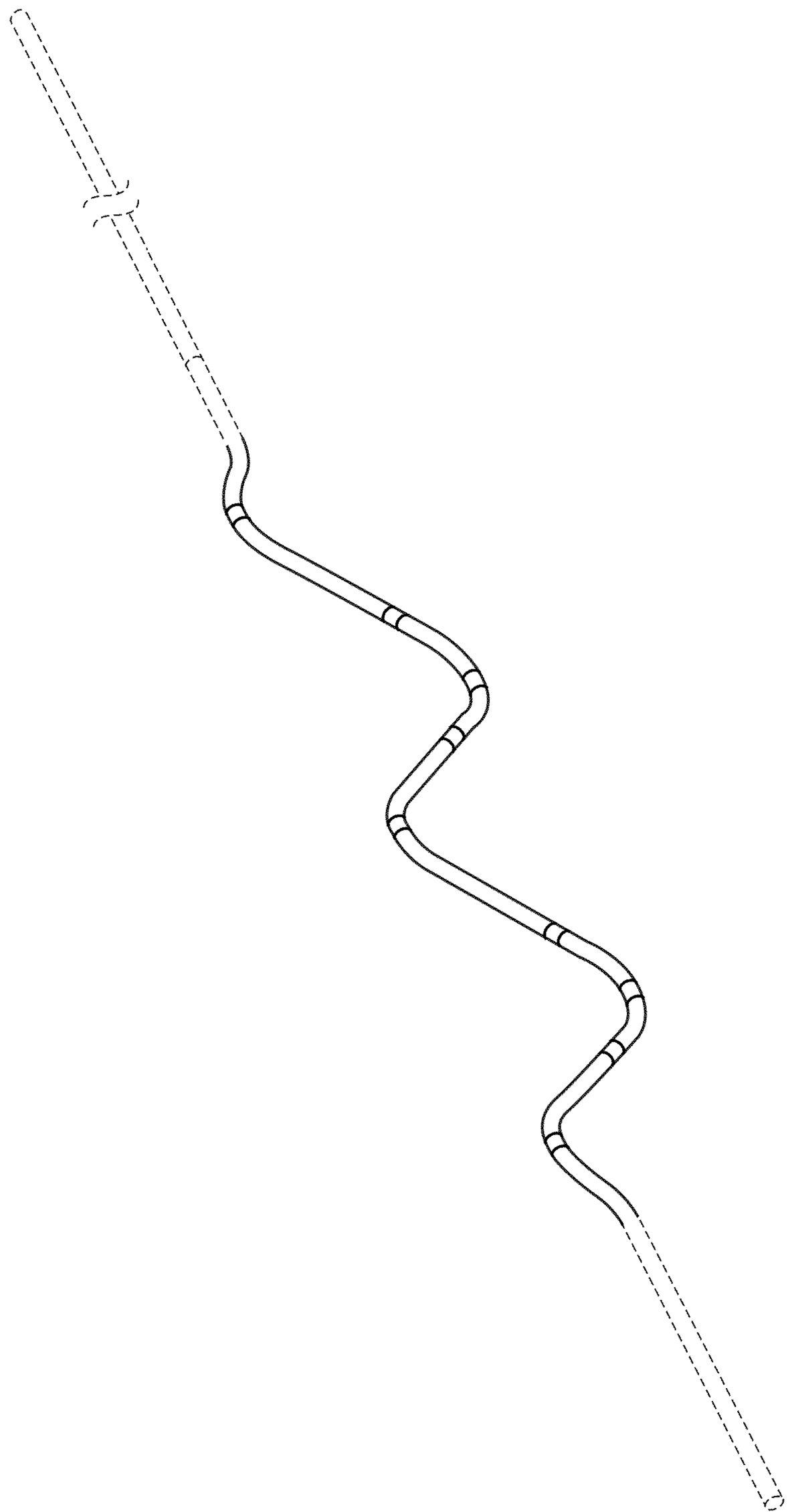

FIG. 8

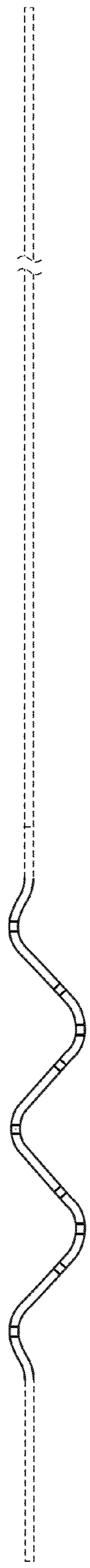

FIG. 9

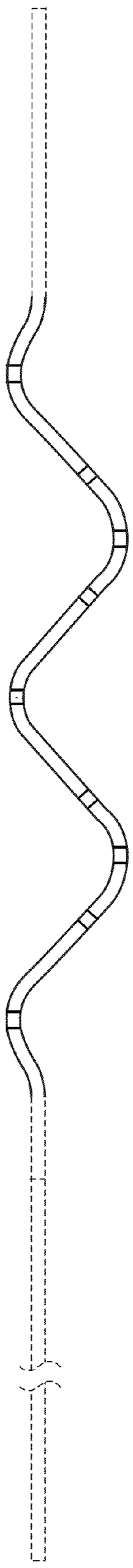

FIG. 10

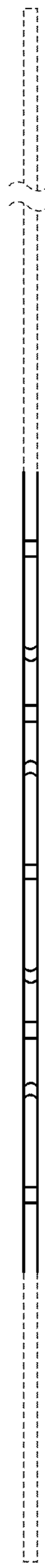

FIG. 11

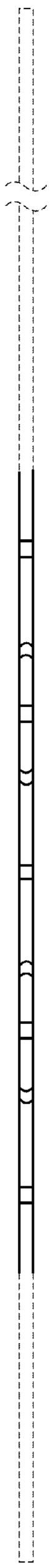

FIG. 12

FIG. 14

FIG. 13